

42390.P10889



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Vu, et al.

Serial No.: 09/884,595

Filed: June 18, 2001

For: Microelectronic Substrates With
Integrated Devices

Examiner: A. Williams

Group Art Unit: 2826


Attorney Docket No.: 42390.P10889

Confirmation No.: 3197

CERTIFICATE OF MAILING

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AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed August 22, 2003, with the time for response
having been extended by one month, please amend the above-referenced application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begin on page 3 of this
paper.

Amendments to the Drawings begin on page 22 of this paper and include an attached new drawing.

Remarks/Arguments begin on page 23 of this paper.

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